

AN11121

USB CCID class smart card reader using LPCXpresso LPC11U14

Rev. 2 — 12 February 2013

Application note

Document information

Info	Content
Keywords	USB CCID, LPCXpresso LPC11U14, smart card, ACOS3, ISO 7816, LPC11U14FHN33; LPC11U14FHI33; LPC11U14FBD48; LPC11U14FET48
Abstract	This application note describes a USB CCID class smart card reader using an LPCXpresso LPC11U14 board. This project implements a smart card reader that conforms to ISO/IEC 7816 protocol. When a CCID device is connected to a USB host, regardless of the presence of a smart card, the CCID prepares to communicate with the host by identifying its capabilities and requirements. When the CCID device detects a smart card insertion, it communicates this information to the host. Once the host receives the information about the smart card, the host communicates with the card through the CCID.



Revision history

Rev	Date	Description
2	20130212	Updated code: Bug fix, deleted some .svn directories
1.1	20111104	Table 1 : Changed P1.19 to P0.19 for Gold Pad I/O.
1	20111006	Initial version.

Contact information

For more information, please visit: <http://www.nxp.com>

For sales office addresses, please send an email to: salesaddresses@nxp.com

1. Introduction

The LPC11U14 is an ARM Cortex-M0 based, low-cost 32-bit MCU, designed for 8/16-bit microcontroller applications, offering performance, low power, simple instruction set and memory addressing together with reduced code size compared to existing 8/16-bit architectures.

The peripheral complement of the LPC11U14 includes 32 kB of flash memory, 6 kB of SRAM data memory, one Fast-mode Plus I²C-bus interface, one RS-485/EIA-485 USART with support for synchronous mode and smart card interface, two SSP interfaces, four general purpose counter/timers, a 10-bit ADC, and up to 40 general purpose I/O pins.

This application note describes a project that implements a USB CCID class smart card reader on an LPCXpresso LPC11U14 board. A smart card that conforms to the ISO7816 T0 protocol is used in this project.

This application note describes the following:

- Smart card basics
- Block diagram/overview of the setup
- Functional description of the system
- Requirements and system setup
- A guide to setup the demonstration
- Applications
- Conclusion

2. Smart card basics

A smart card is made of plastic and contains an embedded chip which either consists of a memory or microprocessor chip that enables the card to store or help in transaction of data. Smart cards are used for the purpose of identification, data storage, and to secure the account information of the user using such cards. [Fig 1](#) depicts an ACOS3 smart card used in this application.



Fig 1. ACOS3 smart card

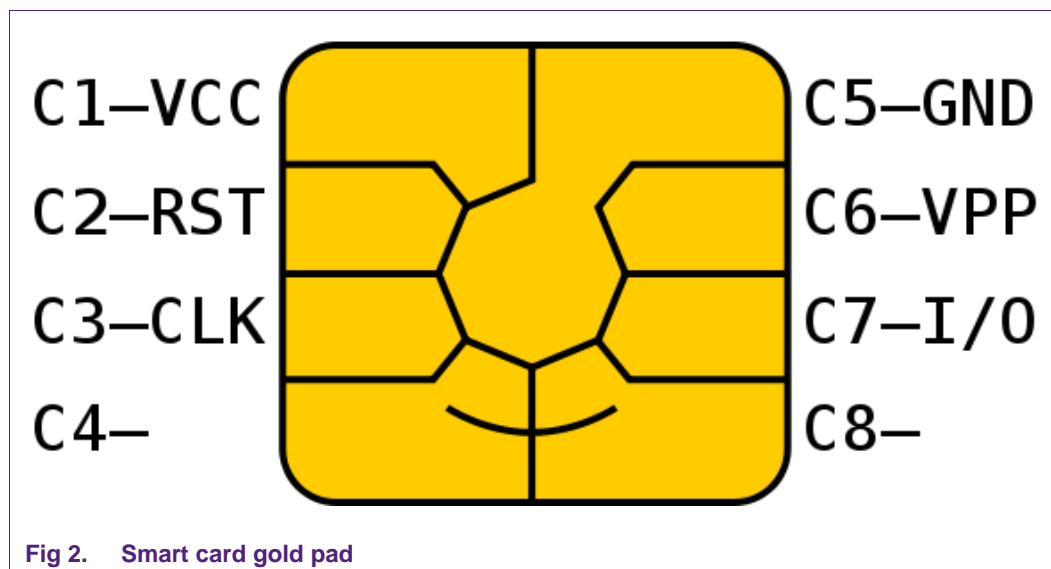
2.1 Types of smart cards

Smart cards can be broadly classified as:

- Contact cards – ISO 7816
- Contactless Cards – ISO 14443

2.1.1 Contact cards

Contact cards are the most common type of smart card. Contact cards conform to ISO7816 protocol. Electrical contacts are bonded to the card through a gold pad, which communicates with a card reader when inserted. This application uses contact cards.



[Fig 2](#) shows a typical gold pad found on smart cards.

2.1.2 Contactless cards

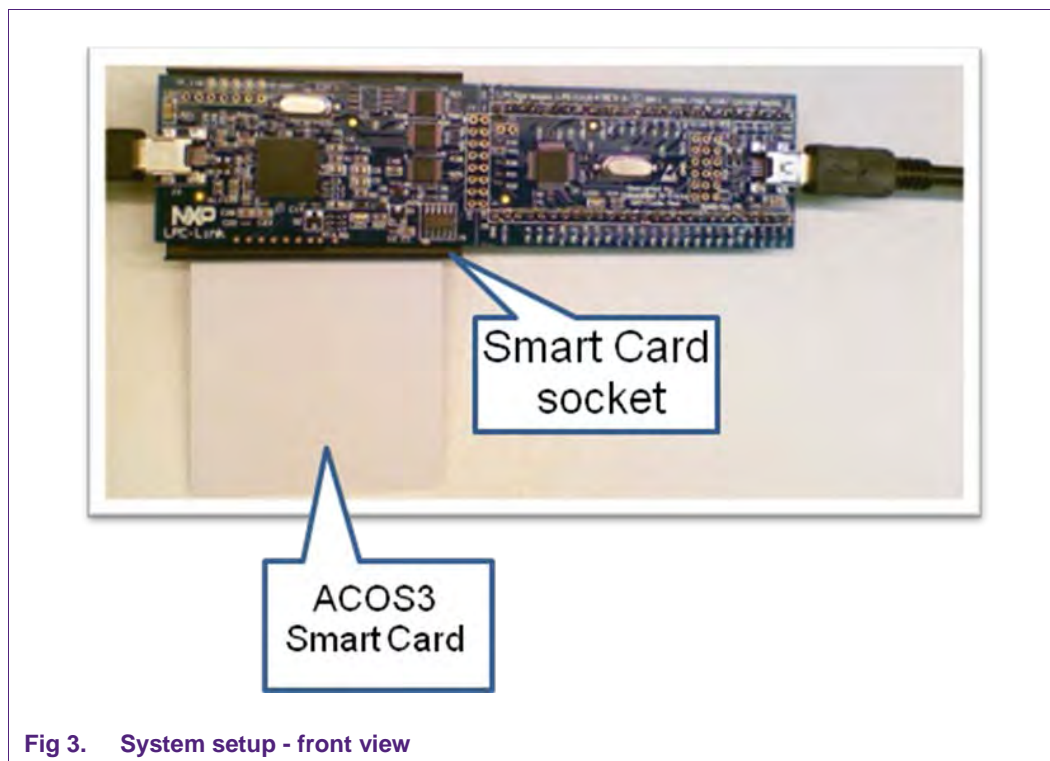
Contactless cards employ Radio-Frequency Identification (RFID) to communicate between the card and reader without physical insertion of the card. These cards conform to the ISO 14443 protocol. In this application, contactless cards are not supported.

A detailed description of smart cards can be found at: <http://www.smartcardbasics.com/>.

3. System setup

An optimal system setup requires the socket holder to be mounted behind the LPCXpresso board. [Fig 3](#) and [Fig 4](#) depict the system setup.

The schematics followed to connect the smart card socket to the necessary pins are described in [Section 3.1](#).



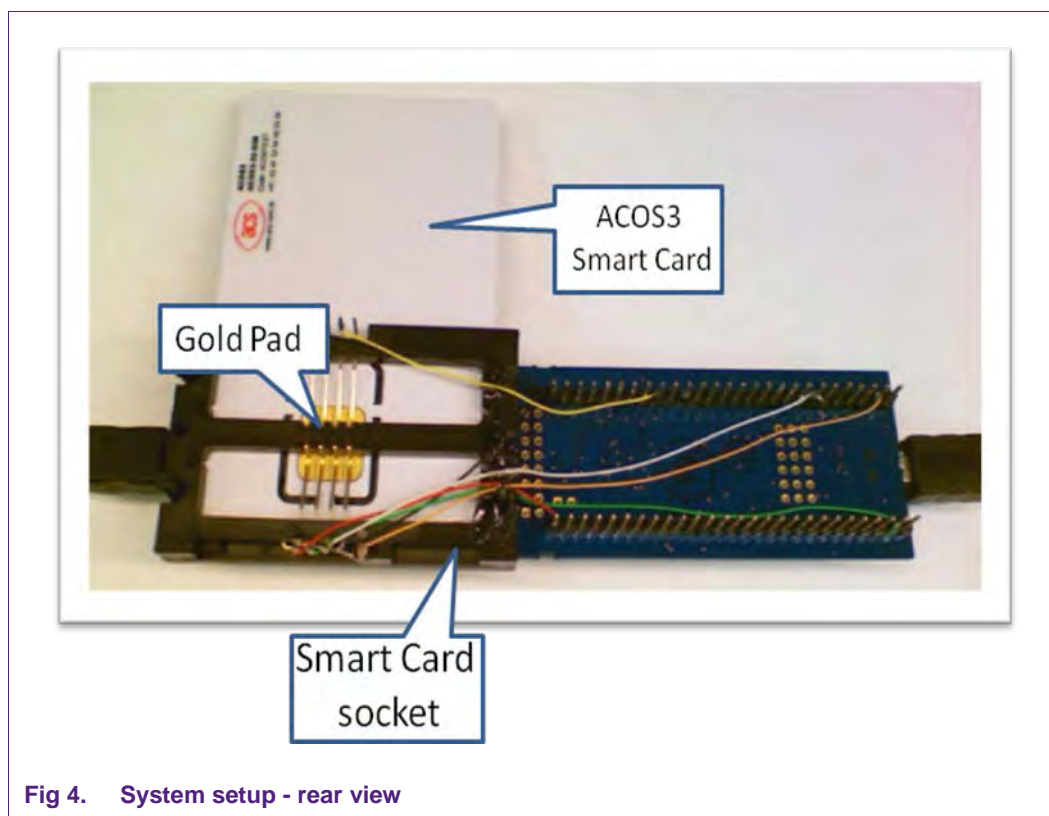


Fig 4. System setup - rear view

3.1 Schematics

The wiring from the card socket to the LPCXpresso board is listed in [Table 1](#).

Table 1. Schematics

Smartcard socket	LPCXpresso
Card detect	P1.14
Gold Pad reset	P1.16
Gold Pad I/O	P0.19
Gold Pad clk	P0.17
Gold Pad power	3.3v
Gold Pad ground	GND

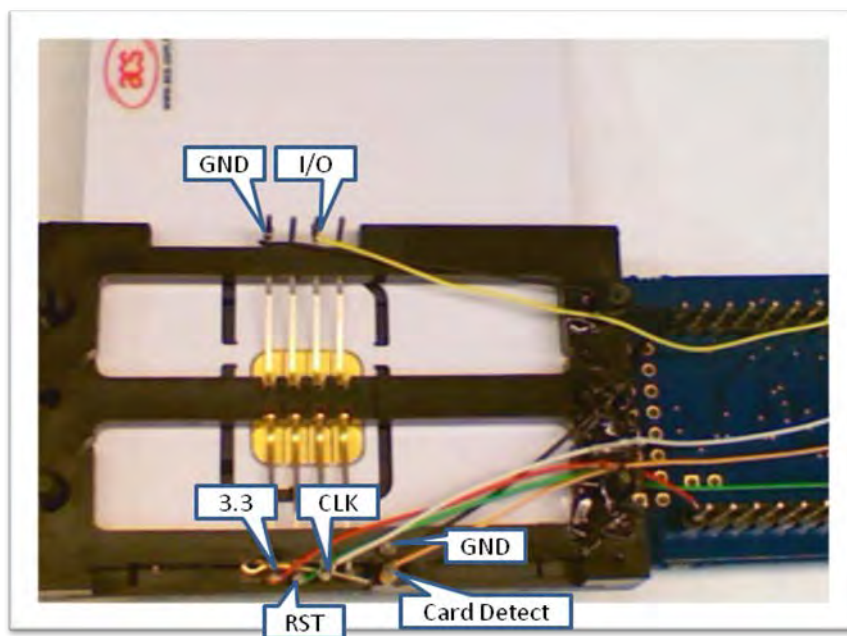


Fig 5. Smart card socket pin details

4. System overview

This project contains a USB CCID class (smart card) example device that runs on top of a USART interface. There are four major components in this example:

1. The USART layer.
2. The generic smartcard (ISO7816) layer.
3. A card specific layer that drives an ACOS3 smart card.
4. USB CCID class layer.

The project allows the user to choose between two different configurations based on the value of USB_CCID defined in *usbcfg.h*:

1. USB_CCID = 1 -> USB CCID device.
2. USB_CCID = 0 -> Stand alone ACOS3 smart card test.

A block diagram of the software components is shown in [Fig 6](#):

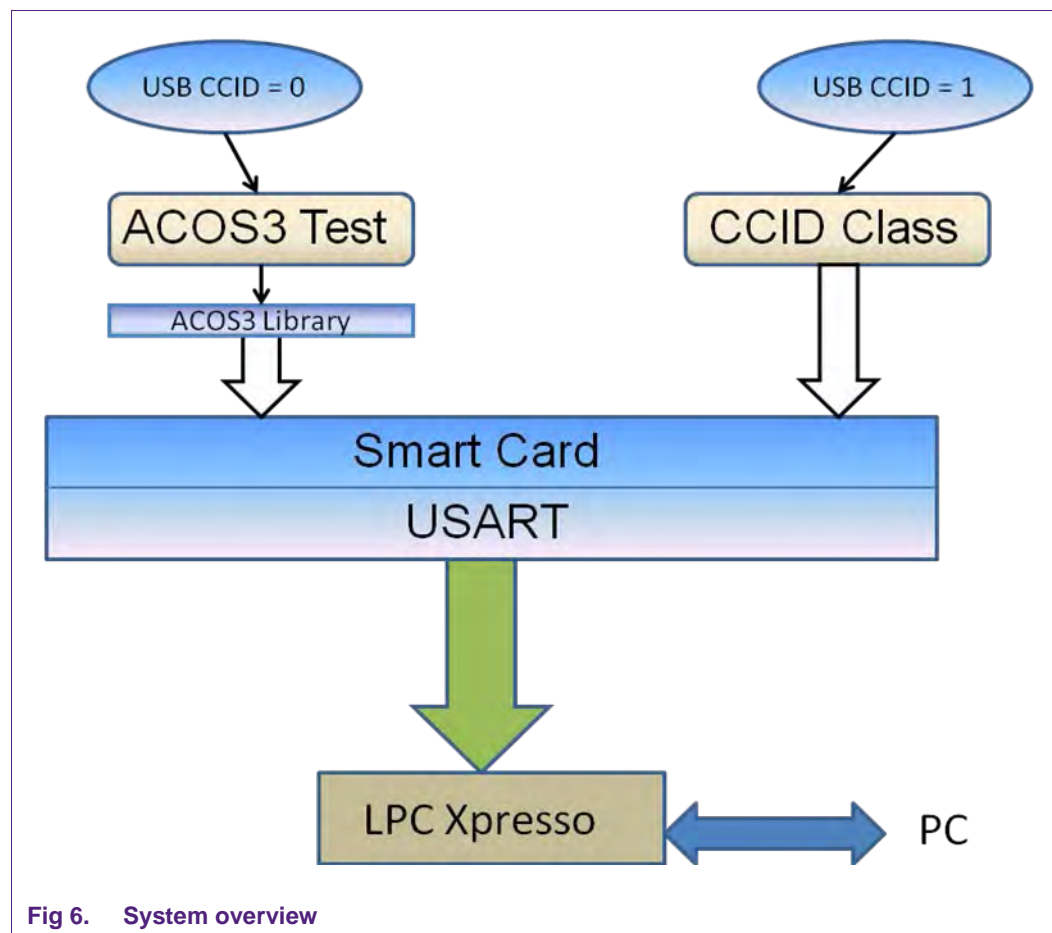


Fig 6. System overview

5. Requirements

5.1 Hardware

- LPCXpresso LPC11U14
- Smart card socket. The socket used in this application can be found at: <http://www.bgmicro.com/soc1021.aspx>
- ACOS3 smart card. The smart card used in this application can be found at: <http://www.acs.com.hk/index.php?pid=product&id=ACOS3>

5.2 Software

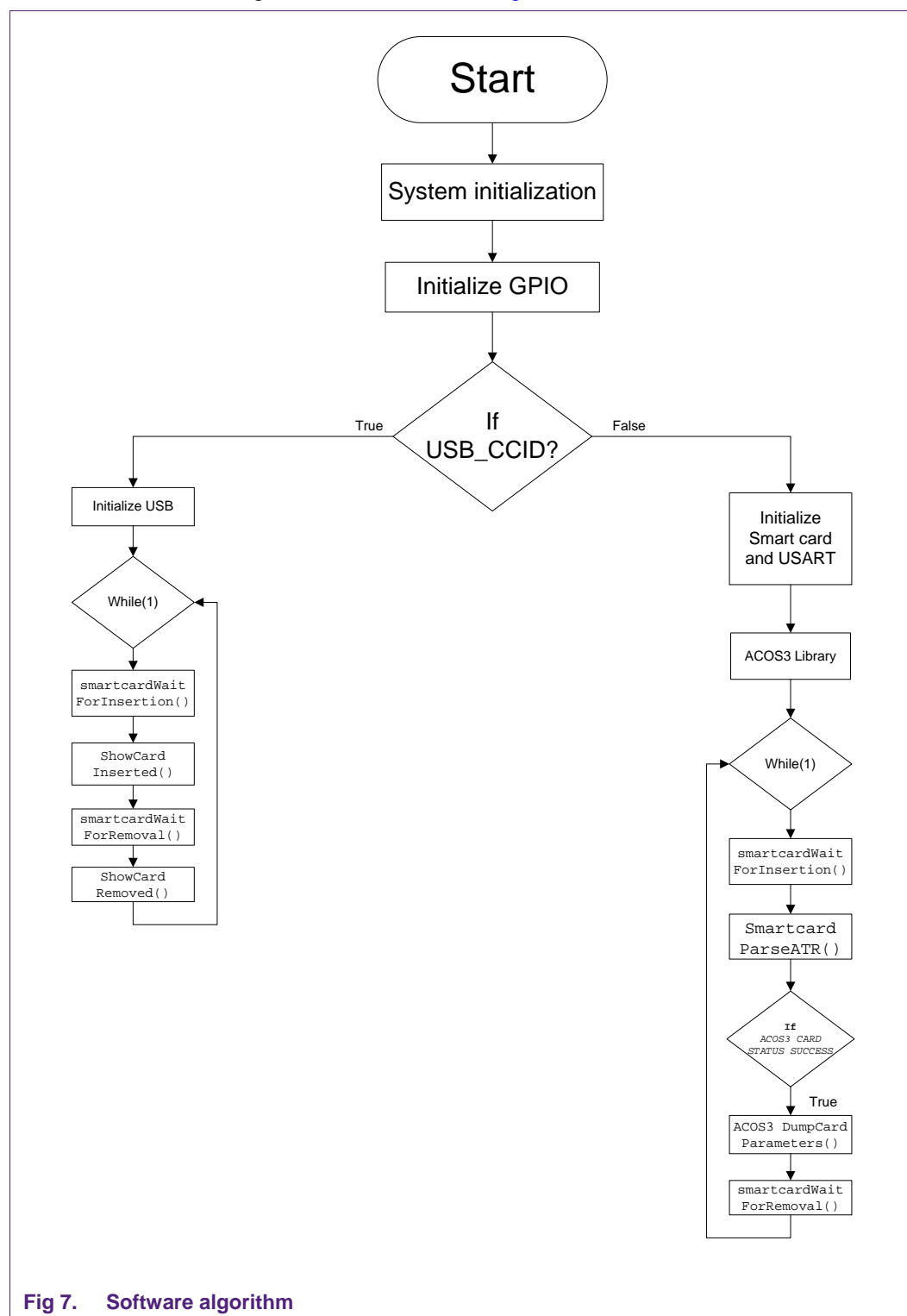
- LPCXpresso IDE, Version 4.0 or later. The download link for the software can be found at: <http://lpcxpresso.code-red-tech.com/LPCXpresso/>

Getting started with NXP LPCXpresso is a detailed description on how to get started, importing, and compiling projects in the LPCXpresso IDE, and can be found at:

http://www.nxp.com/documents/other/LPCXpresso_Getting_Started_Guide.pdf

6. Software algorithm

Two different build configurations are shown in [Fig 7](#):



Once the device is powered up, system initialization is done by setting up the Main clock and enabling the I/O configuration block by enabling the required bits in SYSAHBCLKCTRL register. Then the GPIO block is initialized and the USB_CCID definition is checked. The USB_CCID definition allows the user to switch between using the project as a USB CCID smart card test or as a standalone ACOS smartcard reader.

If USB_CCID = 1 -> USB CCID test

- The USB driver is initialized.
- An endless loop is entered where:
 - A card insertion/removal is detected by an interrupt raised by the smart card holder socket which is connected to P1_14 GPIO.
 - USB CCID class commands are acted upon.

If USB_CCID = 0 -> Smartcard test

- The USART layer is initialized.
- ACOS3 Library is invoked.
- An endless loop is entered where:
 - A card insertion/removal is detected by an interrupt raised by the smart card holder socket which is connected to P1_14 GPIO.
 - A series of commands are sent to the card and the response is displayed.

7. Demonstration

7.1 LED status

The status of the LED on the LPCXpresso board indicates any one of the following:

- Continuously blinking: Indicates that a card has not been inserted yet.
- Continuously On: Indicates that a card has been inserted.
- Activity: When a card insertion is detected, the USART activity is indicated by toggling the LED.

7.2 Smart card reader as a USB CCID device

1. Connect J3 and J8 of the LPCXpresso to the PC.
2. Import the project USBCCID.zip in LPCXpresso IDE.

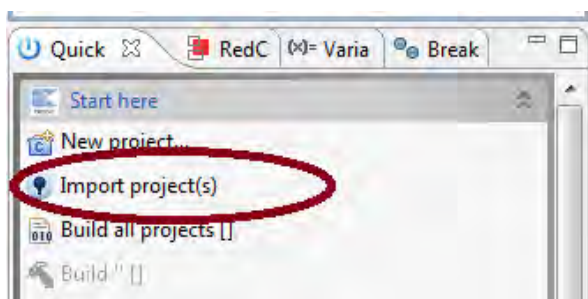


Fig 8. Import project

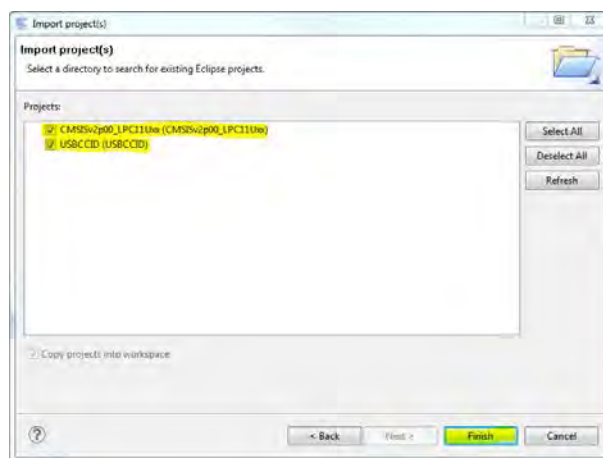


Fig 9. Finish importing project

3. Build and Debug project.

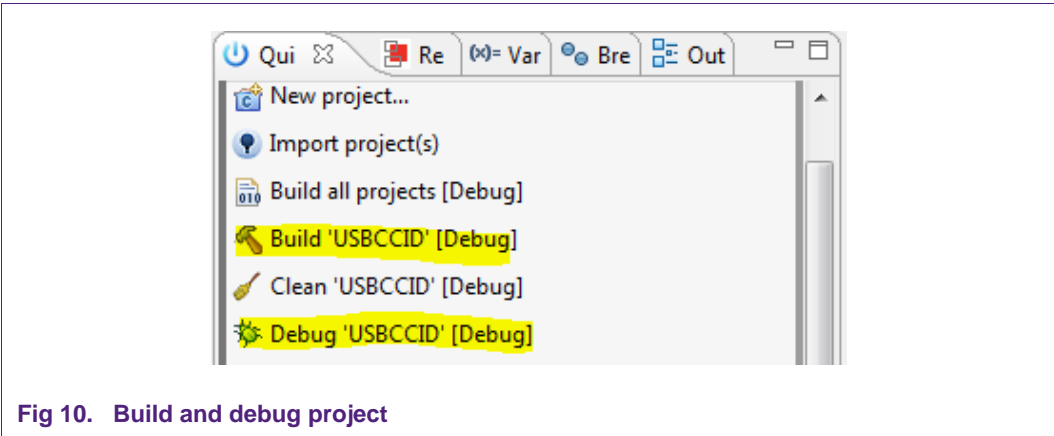


Fig 10. Build and debug project

- 4. Insert the ACOS3 smart card.
- 5. The status LED remains switched on until the card is removed.
- 6. Observe the output as shown below.

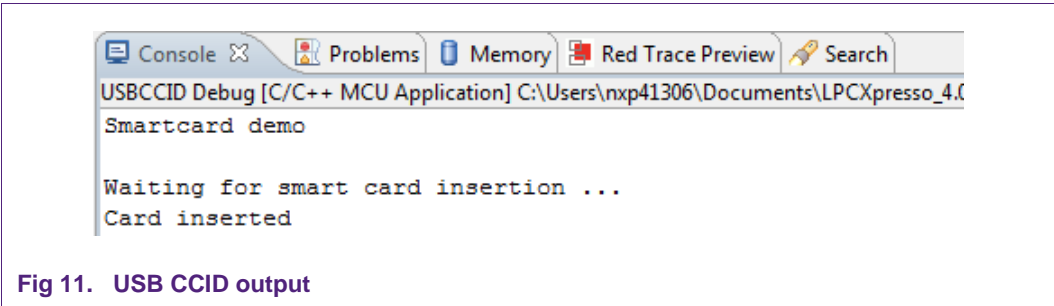


Fig 11. USB CCID output

7.3 Smart card reader as a ACOS3 smart card test device

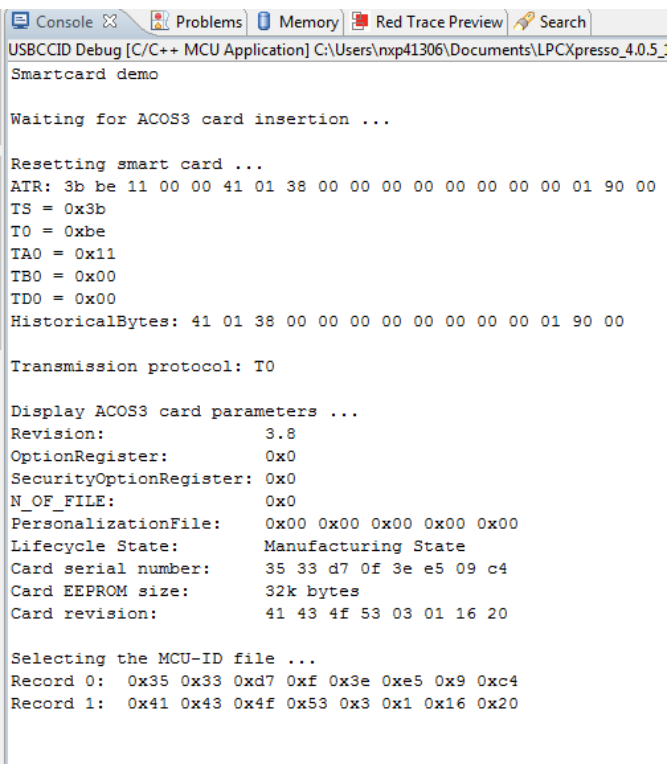
- 1. Maintain the system setup as mentioned above.
- 2. Make the following changes in “USBCCID/src/usbcfg.h”.

```
#define USB_CCID 1

TO

#define USB_CCID 0
```

- 3. Save project, build and debug as mentioned earlier.
- 4. Now Insert the ACOS3 smart card.
- 5. The status LED indicates the USART activity.
- 6. Observe the output as shown below.



The screenshot shows a USBCCID Debug console window with the following text:

```
USBCCID Debug [C/C++ MCU Application] C:\Users\nxp41306\Documents\LPCXpresso_4.0.5_
Smartcard demo

Waiting for ACOS3 card insertion ...

Resetting smart card ...
ATR: 3b be 11 00 00 41 01 38 00 00 00 00 00 00 01 90 00
TS = 0x3b
TO = 0xbe
TA0 = 0x11
TB0 = 0x00
TD0 = 0x00
HistoricalBytes: 41 01 38 00 00 00 00 00 00 00 01 90 00

Transmission protocol: T0

Display ACOS3 card parameters ...
Revision:          3.8
OptionRegister:    0x0
SecurityOptionRegister: 0x0
N_OF_FILE:         0x0
PersonalizationFile: 0x00 0x00 0x00 0x00 0x00
Lifecycle State:   Manufacturing State
Card serial number: 35 33 d7 0f 3e e5 09 c4
Card EEPROM size:  32k bytes
Card revision:     41 43 4f 53 03 01 16 20

Selecting the MCU-ID file ...
Record 0: 0x35 0x33 0xd7 0xf 0x3e 0xe5 0x9 0xc4
Record 1: 0x41 0x43 0x4f 0x53 0x3 0x1 0x16 0x20
```

Fig 12. ACOS parameter dump

8. Conclusion

The USB CCID Smart card reader project demonstrates the capability of LPCXpresso LPC1114 to efficiently utilize the USART, ISO 7816 protocol and successfully implement a USB CCID class example device.

Further, this example device could be used as a standalone smart card reader in commercial products. Enhancements such as a smart card socket that can read various form factors of the smart card (SIM card, micro SIM card) are possible.

9. Legal information

9.1 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

9.2 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the Terms and conditions of commercial sale of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the

customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Evaluation products — This product is provided on an "as is" and "with all faults" basis for evaluation purposes only. NXP Semiconductors, its affiliates and their suppliers expressly disclaim all warranties, whether express, implied or statutory, including but not limited to the implied warranties of non-infringement, merchantability and fitness for a particular purpose. The entire risk as to the quality, or arising out of the use or performance, of this product remains with customer.

In no event shall NXP Semiconductors, its affiliates or their suppliers be liable to customer for any special, indirect, consequential, punitive or incidental damages (including without limitation damages for loss of business, business interruption, loss of use, loss of data or information, and the like) arising out of the use of or inability to use the product, whether or not based on tort (including negligence), strict liability, breach of contract, breach of warranty or any other theory, even if advised of the possibility of such damages.

Notwithstanding any damages that customer might incur for any reason whatsoever (including without limitation, all damages referenced above and all direct or general damages), the entire liability of NXP Semiconductors, its affiliates and their suppliers and customer's exclusive remedy for all of the foregoing shall be limited to actual damages incurred by customer based on reasonable reliance up to the greater of the amount actually paid by customer for the product or five dollars (US\$5.00). The foregoing limitations, exclusions and disclaimers shall apply to the maximum extent permitted by applicable law, even if any remedy fails of its essential purpose.

9.3 Trademarks

Notice: All referenced brands, product names, service names and trademarks are property of their respective owners.

10. Contents

1.	Introduction	3
2.	Smart card basics	4
2.1	Types of smart cards.....	5
2.1.1	Contact cards	5
2.1.2	Contactless cards.....	5
3.	System setup	6
3.1	Schematics.....	7
4.	System overview	9
5.	Requirements	10
5.1	Hardware.....	10
5.2	Software	10
6.	Software algorithm	11
7.	Demonstration	13
7.1	LED status.....	13
7.2	Smart card reader as a USB CCID device	13
7.3	Smart card reader as a ACOS3 smart card test device.....	14
8.	Conclusion.....	16
9.	Legal information	17
9.1	Definitions	17
9.2	Disclaimers.....	17
9.3	Trademarks	17
10.	Contents.....	18

Please be aware that important notices concerning this document and the product(s) described herein, have been included in the section 'Legal information'.
